

Class 2 Bluetooth® Module with EDR Support

Features

- Fully qualified Bluetooth[®] version 2.1 module, supports version 2.1 + Enhanced Data Rate (EDR)
- · ASCII command interface over UART
- · Postage-stamp-sized form factor:
 - RN42: 13.4 x 25.8 x 2.4 mm
 - RN42N: 13.4 x 20.5 x 2.4 mm
- Low-power (26 μA sleep, 3 mA connected, 30 mA transmit)
- UART (SPP or HCI) and USB (HCI only) data connection interfaces
- Sustained SPP data rates: 240 Kbps (Peripheral mode), 300 Kbps (Central mode)
- HCI data rates: 1.5 Mbps sustained, 3.0 Mbps burst in HCI mode
- Embedded Bluetooth stack profiles include: GAP, SDP, RFCOMM, L2CAP protocols, with SPP, HID, and DUN profile support (does not require any host stack)
- · Bluetooth SIG qualified, end product listing
- Castellated SMT pads for easy and reliable PCB mounting
- Class 2 power amplifier with on-board PCB trace antenna (RN42) or external antenna (RN42N)
- Compliance (RN42)
 - Modular Certified for the United States (FCC) and Canada (ISED)
 - European RED Assessed Radio Module
 - Australia/New Zealand/Japan/Korea/Taiwan
 - Bluetooth SIG QDID
- Integrated Crystal, Internal Voltage Regulator, Matching Circuitry, Power Amplifier, Low Noise,



Memory Amplifier and PCB Antenna

- Easy Integration into Final Product Minimize Product Development, Quicker Time to Market
- Compatible with Microchip Microcontroller Families (PIC16F, PIC18F, PIC24F/H, dsPIC33 and PIC32)
- Up to 10 meter range

Applications

- · Cable replacement
- · Barcode scanners
- Measurement and monitoring systems
- · Industrial sensors and controls
- · Medical devices

RN42/RN42N Module Variants ⁽¹⁾					
Model	Antenna	Firmware	Description		
RN42	Integral	4.77, 6.15	Class 2, 2.1+EDR, SPP profile		
RN42HCI	Integral	N/A	Class 2, 2.0+EDR, HCI over UART		
RN42HID	Integral	6.11	Class 2, 2.1+EDR, HID and SPP profiles		
RN42U	Integral	N/A	Class 2, 2.0+EDR, HCl over USB		
RN42APL	Integral	5.36, 5.43, 5.45	Class 2, 2.1+EDR, SPP & MFi profiles		
RN42N	External	4.77, 6.15	Class 2, 2.1+EDR, SPP profile		
RN42NHCI	External	N/A	Class 2, 2.0+EDR, HCI over UART		
RN42NHID	External	6.11	Class 2, 2.1+EDR, HID and SPP profiles		
RN42NU	External	N/A	Class 2, 2.0+EDR, HCI over USB		
RN42NAPL	External	5.36, 5.43, 5.45	Class 2, 2.1+EDR, SPP & MFi profiles		

Note 1: For customer part numbers, see Section 4.0 "Ordering Information". Information on firmware versions can be found on the RN42/RN42N product web page and the "Bluetooth Data Module Command Reference and Advanced Information User's Guide".

Table of Contents

1.0 Device Overview	Ę
2.0 Application Information	
3.0 Regulatory Approval	14
4.0 Ordering Information	19
Product Identification System	
Appendix A: Revision History	23
The Microchip Web Site	
Customer Change Notification Service	25
Customer Support	

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at docerrors@microchip.com. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000000A is version A of document DS30000000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; http://www.microchip.com
- · Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com to receive the most current information on all of our products.

1.0 DEVICE OVERVIEW

The RN42/RN42N module is a small form factor, low-power, class 2 Bluetooth radio that is ideal for designers who want to add wireless capability to their products without spending significant time and money developing Bluetooth-specific hardware and software. The RN42/RN42N supports multiple interface protocols, is simple to design in, and is fully certified, making it a complete embedded Bluetooth solution. With its high-performance, PCB trace antenna (RN42) or external antenna (RN42N), and support for Bluetooth EDR, the RN42/RN42N delivers up to a 3-Mbps data rate for distances up to 10 meters.

1.1 MCU Interface

The RN42/RN42N module is managed through ASCII commands via the UART and/or PIO signals. A microcontroller unit (MCU) or host processor sends commands to configure module features, read status, and manage Bluetooth data connections.

As shown in Figure 1-1, the UART TX and RX are required to communicate with module, and transfer data across Bluetooth SPP connection

Connecting the hardware flow control lines CTS and RTS is highly recommended for applications that transmits a continuous stream of data.

The module can be configured locally via the UART or over-the-air. To support instant cable replacement, auto-discovery/pairing does not require software configuration. Additionally, the module supports auto-connect Central, I/O pin (DTR), and character-based trigger modes.

FIGURE 1-1: RN42/RN42N TO MCU INTERFACE

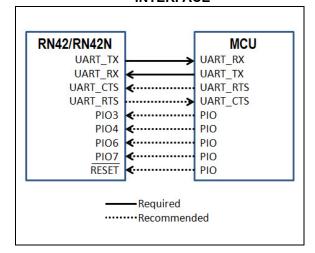


Table 1-1, Table 1-2, Table 1-3, Table 1-4, and Table 1-5 provide the module's environmental conditions, electrical characteristics, dimensions, radio characteristics, and digital I/O characteristics.

1.2 ASCII Command and Data Interface

The "Bluetooth Data Module Advanced User's Guide" provides a complete description of the ASCII command and data interface for the RN42/RN42N module.

TABLE 1-1: ENVIRONMENTAL CONDITIONS

Parameter	Value
Temperature Range (Operating)	-40° C ~ 85° C
Temperature Range (Storage)	-40° C ~ 85° C
Relative Humidity (Operating)	≤ 90%
Relative Humidity (Storage)	≤ 90%
Moisture Sensitivity Level	3

TABLE 1-2: ELECTRICAL CHARACTERISTICS

Parameter	Min.	Тур.	Max.	Units
Supply Voltage (DC)	3.0	3.3	3.6	V
Average Power Consumption	·			
Radio On (Discovery or Inquiry Window Time) ⁽¹⁾	_	40	_	mA
Connected Idle (No Sniff)	_	25	_	mA
Connected Idle (Sniff 100 ms)	_	12	_	mA
Connected with Data Transfer	40	45	50	mA
Deep Sleep Idle Mode	_	26	_	μА

Note 1: This characteristic applies if, in Peripheral mode, there are bursts of radio on time that vary with the windows. The window setting determines the average current.

TABLE 1-3: MODULE DIMENSIONS

Parameter	RN42	RN42N	Units
Size	13.4 x 25.8 x 2.4	13.4 x 20.5 x 2.4	mm
Weight	0.045	0.040	OZ.

TABLE 1-4: RADIO CHARACTERISTICS

Parameter	Frequency (GHz)	Min.	Тур.	Max.	Bluetooth Specification	Units
Sensitivity at 0.1% BER	2.402	_	-80	-86	≤ -70	dBm
	2.441	_	-80	-86		dBm
	2.480	_	-80	-86		dBm
RF Transmit Power ⁽¹⁾	2.402	_	4	_		dBm
RN42	2.441	_	4	_		dBm
	2.480	_	4	_		dBm
RF Transmit Power (1)	2.402	_	4	_		dBm
RN42N	2.441	_	4	_		dBm
	2.480	_	4	_		dBm
Initial Carrier Frequency Tolerance	2.402	_	5	75	75	kHz
	2.441	_	5	75		kHz
	2.480	_	5	75		kHz
20-dB Bandwidth for Modulated Carrier	_	_	900	1000	≤ 1000	kHz
Drift (Five Slots Packet)	_	_	15	_	40	kHz
Drift Rate	_	_	13	_	20	kHz
∆f1 _{avg} Maximum Modulation	2.402	140	165	175	> 140	kHz
	2.441	140	165	175		kHz
	2.480	140	165	175]	kHz
∆f2 _{avg} Minimum Modulation	2.402	140	190	_	115	kHz
-	2.441	140	190	_]	kHz
	2.480	140	190	_]	kHz

Note 1: Normal mode

TABLE 1-5: DIGITAL I/O CHARACTERISTICS

3.0 V ≤ VDD ≤ 3.3 V	Min.	Тур.	Max.	Units
Input Logic Level Low	-0.4	_	+0.8	V
Input Logic Level High	0.7 VDD	_	VDD + 0.4	V
Output Logic Level Low	_	_	0.2	V
Output Logic Level High	VDD - 0.2	_	_	V
All I/O pins (Except reset) Default to Weak Pull Down	+0.2	+1.0	+5.0	μА

Figure 1-2 and Figure 1-3 show the modules' dimensions.

FIGURE 1-2: RN42 MODULE DIMENSIONS

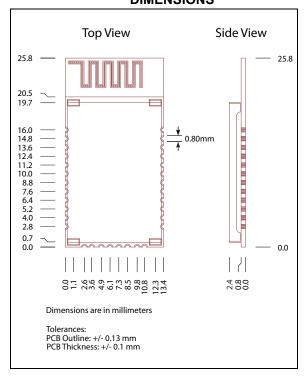


FIGURE 1-3: RN42N MODULE DIMENSIONS

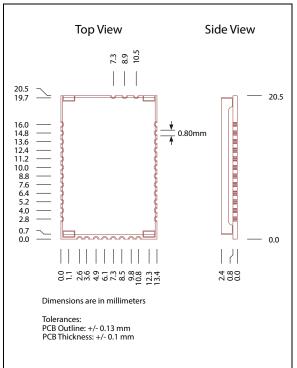


Figure 1-4 and Figure 1-5 show the pinout and Table 1-6 describes the module's pins.

FIGURE 1-4: RN42 PIN DIAGRAM

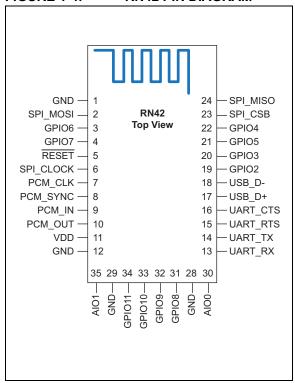


FIGURE 1-5: RN42N PIN DIAGRAM

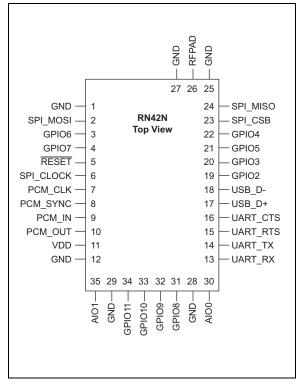


TABLE 1-6: PIN DESCRIPTION

Interface". Set Bluetooth Central. If GPI06	Pin	Symbol	Туре	Description
Interface". Set Bluetooth Central. If CPIO6 = high, module connects to the stored address. If GPIO3 = high, module connects to the stored address. If GPIO3 = high, module connects to the stored address. If GPIO3 = high, module centers new Discovery/Pairing mode.	1	GND	Power	Ground reference
If GPIO6 = high, module connects to the stored address. If GPIO3 = high, module enters new Discovery/Pairing mode. 4	2	SPI_MOSI	DI	(Optional) Factory diagnostic, programming and test. See Section 2.8 "SPI Interface".
Separation	3	GPIO6	DI	If GPIO6 = high, module connects to the stored address.
SPI_CLK DI	4	GPIO7	DIO	Set baud rate (high = force 9,600, low = 115K or firmware setting)
PCM_SYNC DIO (Do not connect) PCM interface ⁽¹⁾	5	RESET	DI	Active-low Reset
B	6	SPI_CLK	DI	(Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface".
9	7	PCM_CLK	DIO	(Do not connect) PCM interface ⁽¹⁾
10	8	PCM_SYNC	DIO	(Do not connect) PCM interface ⁽¹⁾
11	9	PCM IN	DI	(Do not connect) PCM interface ⁽¹⁾
12 GND	10	PCM OUT	DO	
13 UART_RX DI UART receive input 14 UART_TX DO UART transmit output 15 UART_RTS DO UART RTS, goes high to disable host transmitter 16 UART_CTS DI UART CTS, if set high, it disables transmitter 17 USB_D+ DIO USB port. 1.5K pull-up activated when USB port is ready (~500 ms after reseived by the proof of t	11	VDD	Power	Positive Supply
14	12	GND	Power	Ground reference
UART_RTS DO	13	UART RX	DI	UART receive input
16	14	UART TX	DO	UART transmit output
17 USB_D+ DIO USB port. 1.5K pull-up activated when USB port is ready (~500 ms after residual to the process of the device stored in the remote address field and auto-connects. If GPIO6 = low, module enters Peripheral mode with special matching class of 0x55AA. If a device is found, the address of the device stored in the remote address field and auto-connects. If GPIO6 = low, module enters Peripheral mode with special matching class ox55AA and waits for a Central to discover it. 21 GPIO5 DIO Status, toggles based on state, low on connect. See Section 2.3 "Connection Status". 22 GPIO4 DIO Set factory defaults. See Section 2.2 "Factory Reset Using GPIO4". 23 SPI_CSB DI (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 24 SPI_MISO DO (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 25 GND Power Ground reference (RN42N only) 26 RF_ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference 29 GND Power Ground reference 30 AIO0 AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O (remote DTR signal)	15	UART RTS	DO	UART RTS, goes high to disable host transmitter
18	16	UART CTS	DI	
SPIO2 DIO Status, high when connected, low otherwise. See Section 2.3 "Connection Status".	17	USB D+	DIO	USB port. 1.5K pull-up activated when USB port is ready (~500 ms after reset).
Status". 20 GPIO3 DI Auto-discovery mode = high. If GPIO6 = high, module performs device enquiry scan searching for a device with matching class of 0x55AA. If a device is found, the address of the device stored in the remote address field and auto-connects. If GPIO6 = low, module enters Peripheral mode with special matching class 0x55AA and waits for a Central to discover it. 21 GPIO5 DIO Status, toggles based on state, low on connect. See Section 2.3 "Connecti Status". 22 GPIO4 DIO Set factory defaults. See Section 2.2 "Factory Reset Using GPIO4". 23 SPI_CSB DI (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 24 SPI_MISO DO (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 25 GND Power Ground reference (RN42N only) 26 RF ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 A100 AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O (remote DTR signal)	18	USB D-	DIO	USB port
If GPIO6 = high, module performs device enquiry scan searching for a device with matching class of 0x55AA. If a device is found, the address of the device stored in the remote address field and auto-connects. If GPIO6 = low, module enters Peripheral mode with special matching class 0x55AA and waits for a Central to discover it. 21 GPIO5 DIO Status, toggles based on state, low on connect. See Section 2.3 "Connecti Status". 22 GPIO4 DIO Set factory defaults. See Section 2.2 "Factory Reset Using GPIO4". 23 SPI_CSB DI (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 24 SPI_MISO DO (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 25 GND Power Ground reference (RN42N only) 26 RF_ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 AIO0 (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O (remote DTR signal)	19	GPIO2	DIO	Status, high when connected, low otherwise. See Section 2.3 "Connection Status" .
Status". 22 GPIO4 DIO Set factory defaults. See Section 2.2 "Factory Reset Using GPIO4". 23 SPI_CSB DI (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 24 SPI_MISO DO (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 25 GND Power Ground reference (RN42N only) 26 RF_ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 AIO0 AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	20	GPIO3	DI	If GPIO6 = high, module performs device enquiry scan searching for a device with matching class of 0x55AA. If a device is found, the address of the device is stored in the remote address field and auto-connects. If GPIO6 = low, module enters Peripheral mode with special matching class of
23 SPI_CSB DI (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 24 SPI_MISO DO (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 25 GND Power Ground reference (RN42N only) 26 RF ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 AIOO AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	21	GPIO5	DIO	Status, toggles based on state, low on connect. See Section 2.3 "Connection Status" .
24 SPI_MISO DO (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 25 GND Power Ground reference (RN42N only) 26 RF ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 AIOO AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	22	GPIO4	DIO	Set factory defaults. See Section 2.2 "Factory Reset Using GPIO4".
24 SPI_MISO DO (Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface". 25 GND Power Ground reference (RN42N only) 26 RF ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 A100 AIO (Not used) Optional analog input 31 GP108 DO UART TX/RX data activity 32 GP109 DIO I/O 33 GP1010 DIO I/O (remote DTR signal)	23	SPI_CSB	DI	(Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface".
26 RF ANT AIO Antenna, 50-Ohm impedance (RN42N only) 27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 AIOO AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	24		DO	(Optional) Factory diagnostic and test. See Section 2.8 "SPI Interface".
27 GND Power Ground reference (RN42N only) 28 GND Power Ground reference 29 GND Power Ground reference 30 AIOO AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	25	GND	Power	Ground reference (RN42N only)
28 GND Power Ground reference 29 GND Power Ground reference 30 AIO0 AIO (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	26	RF ANT	AIO	Antenna, 50-Ohm impedance (RN42N only)
29 GND Power Ground reference 30 A100 AIO (Not used) Optional analog input 31 GP108 DO UART TX/RX data activity 32 GP109 DIO I/O 33 GP1010 DIO I/O (remote DTR signal)	27	GND	Power	Ground reference (RN42N only)
30 AIO0 (Not used) Optional analog input 31 GPIO8 DO UART TX/RX data activity 32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	28	GND	Power	Ground reference
31 GPI08 DO UART TX/RX data activity 32 GPI09 DIO I/O 33 GPI010 DIO I/O (remote DTR signal)	29	GND	Power	Ground reference
32 GPIO9 DIO I/O 33 GPIO10 DIO I/O (remote DTR signal)	30	AIOO	AIO	(Not used) Optional analog input
33 GPIO10 DIO I/O (remote DTR signal)	31	GPIO8	DO	UART TX/RX data activity
	32	GPIO9	DIO	I/O
34 GPIO11 DIO I/O (remote RTS signal)	33	GPIO10	DIO	I/O (remote DTR signal)
	34	GPIO11	DIO	I/O (remote RTS signal)
35 AIO1 AIO (Not used) Optional analog input	35		AIO	(Not used) Optional analog input

Pin type abbreviation: \mathbf{A} = Analog, \mathbf{D} = Digital, \mathbf{I} = Input, \mathbf{O} = Output.

Note 1: Pin numbers 7 through 10 are reserved for future use.

2.0 APPLICATION INFORMATION

The following sections provide information on designing with the RN42/RN42N module, including radio interference, factory reset, solder reflow profile, connection status, and so on.

2.1 Reset Circuit

The RN42/RN42N contains a weak internal pull-up to VCC, and the reset polarity is active low. The module's reset pin has an optional Power-on Reset circuit with a delay, which should only be required if the input power supply has a very slow ramp or tends to bounce or have instability on power-up. Often a microcontroller or embedded CPU I/O is available to generate the reset once power is stable. If not, designers can use one of the many low-cost power supervisor chips available, such as the MCP809 or MCP102/121.

2.2 Factory Reset Using GPIO4

It is recommended to connect the GPIO4 pin to a switch, jumper, or resistor so it can be accessed. This pin can be used to reset the module to its factory default settings, which is critical in situations where the module has been misconfigure d. To reset the module to the factory defaults, GPIO4 should be high on power-up and then toggle between low and high twice with a 1 second wait between the low-high transitions.

2.3 Connection Status

GPIO5 is available to drive an LED, and it blinks at various speeds to indicate status, see Table 2-1. GPIO2 is an output that directly reflects the connection state as shown in Table 2-2.

TABLE 2-1: GPIO5 STATUS

GPIO5 Status	Description
Toggle at 1 Hz	The module is discoverable and waiting for a connection.
Toggle at 10 Hz	The module is in command mode.
High	The module is connected to another device over Bluetooth.

TABLE 2-2: GPIO2 STATUS

GPIO2 Status	Description
High	The module is connected to another device over Bluetooth.
Low	The module is not connected over Bluetooth.

2.4 Module Mounting Details

Figure 2-1 and Figure 2-2 show the recommended PCB footprint for the RN42 and RN42N, respectively. When laying out the carrier board for the RN42 module, the areas under the antenna and shielding connections should not have surface traces, ground planes, or exposed vias.

Figure 2-3 and Figure 2-4 show the recommended mounting details for the RN42 and RN42N, respectively. For optimal radio performance, the RN42 module's antenna end should protrude at least 31 mm beyond any metal enclosure.

Figure 2-5 shows examples of good, bad, and acceptable positioning of the RN42/RN42N on the host PCB.

FIGURE 2-1: RN42 RECOMMENDED PCB FOOTPRINT

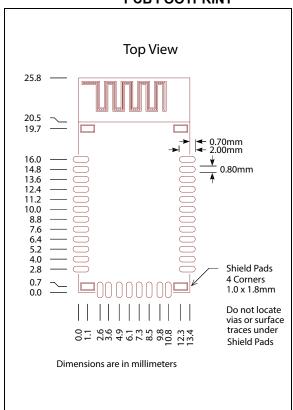


FIGURE 2-2: RN42N RECOMMENDED PCB FOOTPRINT

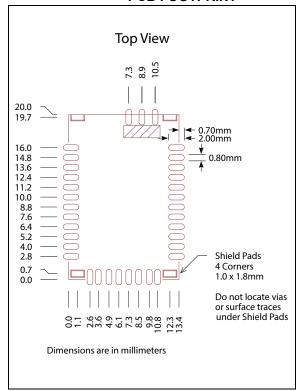


FIGURE 2-3: RN42 MODULE MOUNTING DETAILS

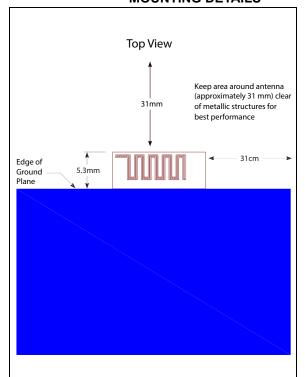
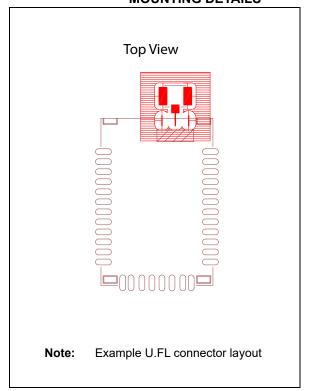


FIGURE 2-4: RN42N MODULE MOUNTING DETAILS



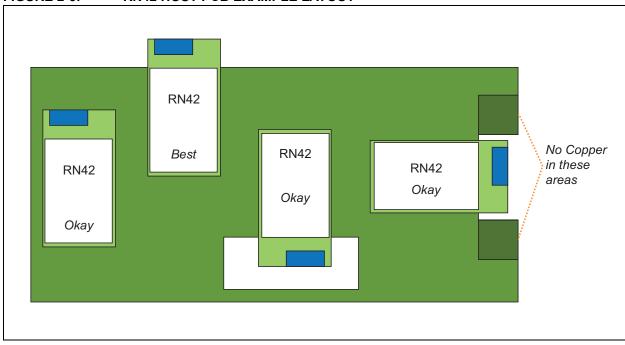


FIGURE 2-5: RN42 HOST PCB EXAMPLE LAYOUT

2.5 External Antenna Types (RN42N)

The RN42N module's antenna pin (pin 26) provides a 50-ohm impedance to external antennas. Pin 25 can connect directly to a coaxial cable or to an antenna connector such as a U.FL or reverse polarity SMA.

The PCB trace from pin 26 to the coaxial cable or connector should be less than 0.2 inches (5 mm) for minimum loss and the best impedance match. If the PCB trace is longer, it should be a 50-ohm impedance microstrip trace. Connect adjacent ground pins 25 and 27 to a low-impedance ground on the host PCB and the antenna connection. Figure 2-4 gives example host PCB layout to a U.FL connector.

2.6 HCI Mode

Microchip offers the Host Controller Interface (HCI) mode in addition to the standard operational mode of its Bluetooth modules (standard mode refers to the onboard stack running on the module).

In HCI mode, the on-board stack is bypassed and the module is put in a state that runs the Bluetooth baseband. The HCI provides a command reference interface to the baseband controller and the link manager, and provides access to the hardware status and control registers. This interface provides a uniform method for accessing the Bluetooth baseband capabilities.

In this mode, the Bluetooth stack is no longer on-board the module. It is offloaded to the interfacing host processor. The Bluetooth module is used as a radio, performing the lower level MAC functionalities, while the application stack runs on the host processor. Using the module in HCI mode enables designers to implement profiles that are not natively supported on the Bluetooth module.

Note: HCI mode is only available by ordering part RN42HCI and RN42HCI for UART interface; or RN42U and RN42U for USB interface.

Microchip offers HCI mode in two hardware interfaces:

- · HCI over UART (RN42HCI-I/RM)
- · HCI over USB (RN42U-I/RM)

2.6.1 HCI OVER UART

In this mode, the hardware interface between the host processor and the Bluetooth module is the UART configured at 115.2Kbps. The UART hardware flow control signals are required between the host processor and the Bluetooth module for the HCI interface to work. Failure to do so can cause the host processor and the Bluetooth module to become out of sync and break the Bluetooth link.

2.6.2 HCI OVER USB

In this mode, the hardware interface between the host processor and the Bluetooth module is the USB. In this architecture, the Bluetooth module is the USB client and the host processor is the USB host.

Using the USB interface offers the advantage of a faster data link between the Bluetooth module and the host processor. With this interface, it is possible to achieve Bluetooth's theoretical maximum throughput of 3 Mpbs.

2.7 Soldering Recommendations

The RN42/RN42N wireless module was assembled using standard lead-free reflow profile IPC/JEDEC J-STD-020.

The module can be soldered to the host PCB using standard leaded and lead-free solder reflow profiles.

To avoid damaging the module, the following recommendations are given:

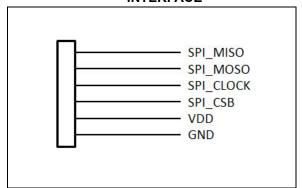
- Microchip Technology Application Note," AN233 Solder Reflow Recommendation" (DS00233) provides solder reflow recommendations
- Do not exceed peak temperature (T_p) of 250 C°
- Refer to the Solder Paste data sheet for specific reflow profile recommendations
- Use no-clean flux solder paste
- Do not wash as moisture can be trapped under the shield
- Use only one flow. If the PCB requires multiple flows, apply the module on the final flow.

2.8 SPI Interface

The SPI Interface is primarily used for factory programming, test, and diagnostics. Although not required, the SPI interface is useful for restoring a corrupted flash image or enabling test modes required for certification testing.

When module is installed in a final product that requires European type approval, see **Section 3.3 "Europe"**, it is recommended that the SPI interface should be accessible via 6-pin header as shown in Figure 2-6.

FIGURE 2-6: OPTIONAL SPI INTERFACE



2.9 Bluetooth SIG QDID

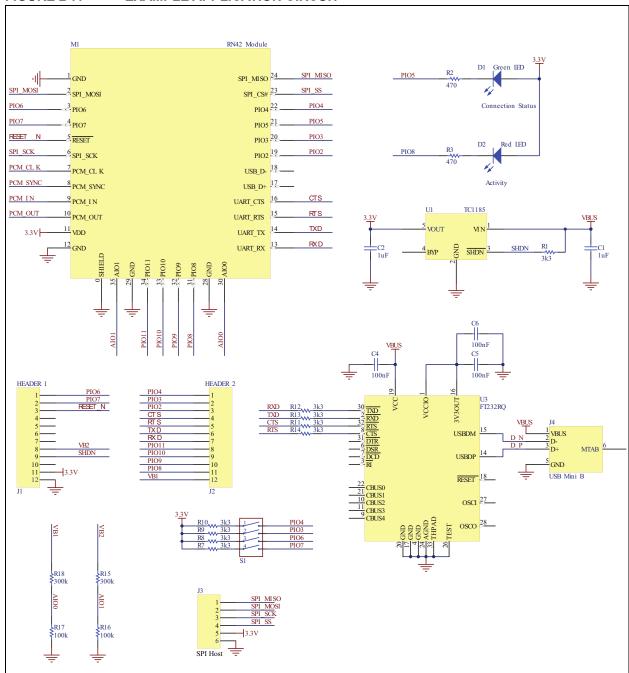
The RN42 has a QDID registered with the Bluetooth SIG. The manufacturer using the RN42 module in their end product can reference this QDID when filing an EPL (end product listing) to use Bluetooth[®] brand and logo. For more information, please visit the Bluetooth SIG at www.bluetooth.org.

QDID: B014867

2.10 Application Schematic

Figure 2-7 shows an example application circuit. This schematic is for the RN-42-EK development tool. For details on how to connect RN42/RN42N to a microcontroller, see **Section 1.1 "MCU Interface"**.

FIGURE 2-7: EXAMPLE APPLICATION CIRCUIT



3.0 REGULATORY APPROVAL

This section outlines the regulatory information for the RN42 module for the following countries:

- · United States
- Canada
- Europe
- · Australia
- New Zealand
- Japan
- Korea
- Taiwan

3.1 United States

The RN42 module has received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Subpart C "Intentional Radiators" modular approval in accordance with Part 15.212 Modular Transmitter approval. Modular approval allows the end user to integrate the RN42 module into a finished product without obtaining subsequent and separate FCC approvals for intentional radiation, provided no changes or modifications are made to the module circuitry. Changes or modifications could void the user's authority to operate the equipment. The end user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

The finished product is required to comply with all applicable FCC equipment authorizations regulations, requirements and equipment functions not associated with the transmitter module portion. For example, compliance must be demonstrated to regulations for other transmitter components within the host product; to requirements for unintentional radiators (Part 15 Subpart B "Unintentional Radiators"), such as digital devices, computer peripherals, radio receivers, etc.; and to additional authorization requirements for the non-transmitter functions on the transmitter module (i.e., Verification, or Declaration of Conformity) (e.g., transmitter modules may also contain digital logic functions) as appropriate.

3.1.1 LABELING AND USER INFORMATION REQUIREMENTS

The RN42 module has been labeled with its own FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording as follows:

Contains Transmitter Module FCC ID: T9J-RN42

or

Contains FCC ID: T9J-RN42

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

A user's manual for the product should include the following statement:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Additional information on labeling and user information requirements for Part 15 devices can be found in KDB Publication 784748 available at the FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB) http://apps.fcc.gov/oetcf/kdb/index.cfm.

3.1.2 RF EXPOSURE

All transmitters regulated by FCC must comply with RF exposure requirements. KDB 447498 General RF Exposure Guidance provides guidance in determining whether proposed or existing transmitting facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC).

From the FCC Grant: Power Output listed is conducted. This module must be installed by the OEM or OEM integrator. Instructions on installation of this module may not be provided to the end user. The antenna used for this transmitter must not be co-located with any other transmitters except in accordance with FCC multitransmitter product. procedures. Installers must be provided with antenna installation instructions for satisfying RF exposure compliance. Installers and end users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

3.1.3 APPROVED ANTENNAS

To maintain modular approval in the United States, only the antenna types that have been tested shall be used. It is permissible to use different antenna, provided the same antenna type, antenna gain (equal to or less than), with similar in-band and out-of band characteristics (refer to specification sheet for cutoff frequencies).

3.1.4 HELPFUL WEBSITES

Federal Communications Commission (FCC): http://www.fcc.gov

FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB): http://apps.fcc.gov/oetcf/kdb/index.cfm

3.2 Canada

The RN42 module has been certified for use in Canada under Innovation, Science and Economic Development Canada (ISED, formerly Industry Canada) Radio Standards Specification (RSS) RSS-210 and RSSGen. Modular approval permits the installation of a module in a host device without the need to recertify the device.

3.2.1 LABELING AND USER INFORMATION REQUIREMENTS

Labeling Requirements for the Host Device (from RSP-100, Issue 12, Section 5): The host device shall be properly labeled to identify the module within the host device.

The Industry Canada certification label of a module shall be clearly visible at all times when installed in the host device, otherwise the host device must be labeled to display the Industry Canada certification number of the module, preceded by the words "Contains transmitter module", or the word "Contains", or similar wording expressing the same meaning, as follows:

RN42:

Contains transmitter module IC: 6514A-RN42

User Manual Notice for License-Exempt Radio Apparatus (from Section 8.4 RSS-Gen, Issue 5, March 2019): User manuals for license-exempt radio apparatus shall contain the following or equivalent notice in a conspicuous location in the user manual or alternatively on the device or both:

This device contains license-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's license-exempt RSS(s). Operation is subject to the following two conditions:

- 1. This device may not cause interference;
- 2. This device must accept any interference, including interference that may cause undesired operation of the device.
- L'émetteur/récepteur exempt de licence contenu dans le présent appareil est conforme aux CNR d'Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:
- 1. L'appareil ne doit pas produire de brouillage;
- 2. L'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Transmitter Antenna (From Section 6.8 RSS-GEN, Issue 5, March 2019): User manuals, for transmitters shall display the following notice in a conspicious location:

This radio transmitter [IC: 6514A-RN42] has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

Le présent émetteur radio [IC: 6514A-RN42] a été approuvé par Innovation, Sciences et Développement économique Canada pour fonctionner avec les types d'antenne énumérés cidessous et ayant un gain admissible maximal Les types d'antenne non inclus dans cette liste, et dont le gain est supérieur au gain maximal indiqué pour tout type figurant sur la liste, sont strictement interdits pour l'exploitation de l'émetteur.

Immediately following the above notice, the manufacturer shall provide a list of all antenna types approved for use with the transmitter, indicating the maximum permissible antenna gain (in dBi) and required impedance for each.

3.2.2 RF EXPOSURE

All transmitters regulated by Innovation, Science and Economic Development Canada (ISED) must comply with RF exposure requirements listed in RSS-102 - Radio Frequency (RF) Exposure Compliance of Radio-communication Apparatus (All Frequency Bands).

3.2.3 HELPFUL WEB SITES

Industry Canada: http://www.ic.gc.ca

3.3 Europe

The RN42 module is Radio Equipment Directive (RED) assessed, CE marked, and have been manufactured and tested with the intention of being integrated into a final product.

The RN42 module has been tested to RED 2014/53/EU Essential Requirements mentioned in the following European Compliance table.

TABLE 3-1: EUROPEAN COMPLIANCE

Certification	Standards	Article
Safety	EN 62368	3.1a
Health	EN 62311	
Electro Magnetic	EN 301 489-1	3.1b
Compatibility (EMC)	EN 301 489-17	
Radio	EN300 328	3.2

The ETSI provides guidance on modular devices in "Guide to the application of harmonised standards cov-

ering Article 3.1b and Article 3.2 of the Directive 2014/53/EU RED to multi-radio and combined radio and non-radio equipment" document available at http://www.etsi.org/deliver/etsi_eg/203300_203399/203367/01.01.01 60/eg 203367v010101p.pdf.

Note:

To maintain conformance to the standards listed in the preceding European Compliance table, the module shall be installed in accordance with the installation instructions in this data sheet and shall not be modified. When integrating a radio module into a completed product, the integrator becomes the manufacturer of the final product and is therefore responsible for demonstrating compliance of the final product with the essential requirements against the RED.

3.3.1 LABELING AND USER INFORMATION REQUIREMENTS

The label on the final product which contains the RN42 module must follow CE marking requirements.

3.3.2 CONFORMITY ASSESSMENT

From ETSI Guidance Note EG 203367, section 6.1 Non-radio products are combined with a radio product:

If the manufacturer of the combined equipment installs the radio product in a host non-radio product in equivalent assessment conditions (i.e. host equivalent to the one used for the assessment of the radio product) and according to the installation instructions for the radio product, then no additional assessment of the combined equipment against article 3.2 of the RED is required.

3.3.2.1 SIMPLIFIED EU DECLARATION OF CONFORMITY

Hereby, Microchip Technology Inc. declares that the radio equipment type RN42 is in compliance with Directive 2014/53/EU.

The full text of the EU declaration of conformity for this product is available at

https://www.microchip.com/wwwproducts/en/RN42

(available under Documents > Certifications).

3.3.3 APPROVED ANTENNAS

For RN42, the approval is received using the antenna shown in Figure 2-1.

3.3.4 HELPFUL WEB SITES

A document that can be used as a starting point in understanding the use of Short Range Devices (SRD) in Europe is the European Radio Communications Committee (ERC) Recommendation 70-03 E, which

can be downloaded from the European Radio Communications Committee (ECC) at: http://www.ecodocdb.dk/.

Additional helpful web sites are:

- Radio Equipment Directive (2014/53/EU): https:// ec.europa.eu/growth/single-market/europeanstandards/harmonised-standards/red en
- European Conference of Postal and Telecommunications Administrations (CEPT): http://www.cept.org
- European Telecommunications Standards Institute (ETSI): http://www.etsi.org
- The Radio Equipment Directive Compliance Association (REDCA): http://www.redca.eu/

3.4 Australia

The Australia radio regulations do not provide a modular approval policy similar to the United States (FCC) and Canada (ISED). However, RN42 module RF transmitter test reports can be used in part to demonstrate compliance in accordance with ACMA Radio communications "Short Range Devices" Standard 2004 (The Short Range Devices standard calls up the AS/NZS 4268:2008 industry standard). The RN42/RN42N module test reports can be used as part of the product certification and compliance folder. For more information on the RF transmitter test reports, contact Microchip Technology Australia sales office.

To meet overall Australian final product compliance, the developer must construct a compliance folder containing all relevant compliance test reports e.g. RF, EMC, electrical safety and DoC (Declaration of Conformity) etc. It is the responsibility of the integrator to know what is required in the compliance folder for ACMA compliance. All test reports are available on the RN42 product web page at http://www.microchip.com. For more information on Australia compliance, refer to the Australian Communications and Media Authority web site http://www.acma.gov.au.

3.4.1 HELPFUL WEB SITES

The Australian Communications and Media Authority: http://www.acma.gov.au.

3.5 New Zealand

The New Zealand radio regulations do not provide a modular approval policy similar to the United States (FCC) and Canada (ISED). However, RN42 module RF transmitter test reports can be used in part to demonstrate compliance against the New Zealand "General User Radio License for Short Range Devices". New Zealand Radio communications (Radio Standards) Notice 2010 calls up the AS / NZS 4268:2008 industry standard. The RN42 module test reports can be used as part of the product certification and compliance folder. All test reports are available on the RN42 product web page at http://www.microchip.com. For more information on the RF transmitter test reports, contact Microchip Technology sales office.

Information on the New Zealand short range devices license can be found in the following web links:

- http://www.rsm.govt.nz/cms/licensees/types-oflicence/general-user-licences/short-range-devices
- http://www.rsm.govt.nz/cms/policy-and-planning/ spectrum-policy-overview/legislation/gazettenotices/product-compliance/radiocommunications-radiostandards-notice-2010.

To meet overall New Zealand final product compliance, the developer must construct a compliance folder containing all relevant compliance test reports e.g. RF, EMC, electrical safety and DoC (Declaration of Conformity) etc. It is the responsibility of the developer to know what is required in the compliance folder for New Zealand Radio communications. For more information on New Zealand compliance, refer to the web site http://www.rsm.govt.nz.

3.5.1 HELPFUL WEB SITES

Radio Spectrum Ministry of Economic Development: http://www.rsm.govt.nz.

3.6 Japan

The RN42 module has received type certification and is labeled with its own technical conformity mark and certification number as required to conform to the technical standards regulated by the Ministry of Internal Affairs and Communications (MIC) of Japan pursuant to the Radio Act of Japan.

Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed. Additional testing may be required:

If the host product is subject to electrical appliance safety (for example, powered from an AC mains), the host product may require Product Safety Electrical Appliance and Material (PSE) testing. The integrator should contact their conformance laboratory to determine if this testing is required.

There is an voluntary Electromagnetic Compatibility (EMC) test for the host product administered by VCCI: http://www.vcci.jp/vcci_e/index.html.

3.6.1 LABELING AND USER INFORMATION REQUIREMENTS

The label on the final product which contains the RN42 module must follow Japan marking requirements. The integrator of the module should refer to the labeling requirements for Japan available at the Ministry of Internal Affairs and Communications (MIC) website.

The RN42 module is labeled with its own technical conformity mark and certification number. The final product in which this module is being used must have a label referring to the type certified module inside:

Contains transmitter module with certificate number:



3.6.2 HELPFUL WEB SITES

Ministry of Internal Affairs and Communications (MIC):

http://www.tele.soumu.go.jp/e/index.htm

Association of Radio Industries and Businesses (ARIB): http://www.arib.or.jp/english

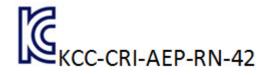
3.7 Korea

The RN42 module has received certification of conformity in accordance with the Radio Waves Act. Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed.

3.7.1 LABELING AND USER INFORMATION REQUIREMENTS

The label on the final product which contains the RN42 module must follow KC marking requirements. The integrator of the module should refer to the labeling requirements for Korea available on the Korea Communications Commission (KCC) website.

The RN42 module is labeled with its own KC mark. The final product requires the KC mark and certificate number of the module:



3.7.2 HELPFUL WEB SITES

Korea Communications Commission (KCC):

http://www.kcc.go.kr

National Radio Research Agency (RRA):

http://rra.go.kr

3.8 Taiwan

The RN42 module has received compliance approval in accordance with the Telecommunications Act. Customers seeking to use the compliance approval in their product should contact Microchip Technology sales or distribution partners to obtain a Letter of Authority.

Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed.

3.8.1 LABELING AND USER INFORMATION REQUIREMENTS

The RN42 module is labeled with its own NCC mark and certificate number as below:



The user's manual should contain below warning (for RF device) in traditional Chinese:

注意!

依據低功率電波輻射性電機管理辦法

第十二條經型式認證合格之低功率射頻電機,非經許可,

公司、商號或使用者均不得擅自變更頻率、加大功率或變更原設計 之特性及功能。

第十四條低功率射頻電機之使用不得影響飛航安全及干擾合法通信;

經發現有干擾現象時,應立即停用,並改善至無干擾時方得繼續使用。

前項合法通信,指依電信規定作業之無線電信。

低功率射頻電機須忍受合法通信或工業、科學及醫療用電波輻射性電機設備之干擾。

3.8.2 HELPFUL WEB SITES

National Communications Commission (NCC):

http://www.ncc.gov.tw

4.0 ORDERING INFORMATION

Table 4-1 provides ordering information for the RN42 module.

TABLE 4-1: ORDERING INFORMATION⁽¹⁾

Part Number ⁽¹⁾	Firmware ⁽²⁾	Description
RN42-I/RM	6.15	Class 2, 2.1+EDR, SPP profile
RN42-I/RM615	6.15	Class 2, 2.1+EDR, SPP profile
RN42-I/RM477	4.77	Class 2, 2.1+EDR, SPP profile
RN42HCI-I/RM	N/A	Class 2, 2.0+EDR, HCI over UART
RN42HID-I/RM	6.11	Class 2, 2.1+EDR, HID and SPP profiles
RN42U-I/RM	N/A	Class 2, 2.0+EDR, HCI over USB
RN42APL-I/RM	5.45	Class 2, 2.1+EDR, SPP and MFi profiles
RN42APL-I/RM545	5.45	Class 2, 2.1+EDR, SPP and MFi profiles
RN42APL-I/RM543	5.43	Class 2, 2.1+EDR, SPP and MFi profiles
RN42N-I/RM	6.15	Class 2, 2.1+EDR, SPP profile
RN42NHCI-I/RM	N/A	Class 2, 2.0+EDR, HCI over UART
RN42NHID-I/RM	6.11	Class 2, 2.1+EDR, HID and SPP profiles
RN42NU-I/RM	N/A	Class 2, 2.0+EDR, HCl over USB
RN42NAPL-I/RM	5.45	Class 2, 2.1+EDR, SPP and MFi profiles

Note 1: For other configurations, contact Microchip drectly.

Go to http://www.microchip.com for current pricing and a list of distributors carrying Microchip products.

^{2:} It is highly recommended that customers order part numbers by specific firmware version when available to ensure consistent receipt of their designed-in firmware version. Information on firmware versions can be found on the RN42/RN42N product web page and the "Bluetooth Data Module Command Reference and Advanced Information User's Guide".

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	ļ	<u>RM</u>	XXX	Exa	imples:	
Device	Temperature Range	 Package	Firmware	a)	RN42-I/RM:	Integral Antenna, Firmware version 6.15
	Nange		Revision Number	b)	RN42-I/RM615:	Integral Antenna, Firmware version 6.15
Device:	RN42 : UART, Integral Antenna RN42N : UART, External Antenna RN42HCI: UART, HCI firmware, Inte		ıral Antenna	c)	RN42APL-I/RM:	Integral Antenna, Firmware version 5.45, SPP and MFi firmware
		- , 3		d)	RN42N-I/RM:	External Antenna, Firmware version 6.15
Temperature Range:	I = -40°C to +	85°C				
Package: *	RM = Radio Mod	dule				
	*All package offerings	s are Pb (Lead) Free				

NOTES:

APPENDIX A: REVISION HISTORY

Revision B (March 2021)

- Updated Figure 1-4 and Figure 1-5
- Added Section 3.1.3 "Approved Antennas"
- Updated Section 3.2.1 "Labeling and User Information Requirements" and Section 3.3 "Europe"
- Updated with the new terminologies; for more details, see the below note

Note:

Microchip is aware that some terminologies used in the technical documents and existing software codes of this product are outdated and unsuitable. This document may use these new terminologies, which may or may not reflect on the source codes, software GUIs, and the documents referenced within this document. The following table shows the relevant terminology changes made in this document.

TABLE 4-2: TERMINOLOGY RELATED CHANGES

Old Terminology	New Terminology	Description		
Master	Central	Updated the following with new terminology:		
		Section "Features"		
		Section 1.1 "MCU Interface"		
		• Table 1-6		
Master	Host	Updated SPI Master to SPI Host in the Figure 2-7		
Slave	Peripheral	Updated the following with new terminology:		
		Section "Features"		
		• Table 1-6		
Slave	Client	Updated USB Slave to USB Client in Section 2.6.2 "HCl over USB"		

Revision A (January 2015)

This is the initial released version of the document in the Microchip format. This replaces Roving Networks RN42/RN42N Data Sheet.

NOTES:

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- · Distributor or Representative
- · Local Sales Office
- · Field Application Engineer (FAE)
- · Technical Support

Customers should contact their distributor, representative or Field Application Engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://microchip.com/support

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods being used in attempts to breach the code protection features of the Microchip devices. We believe that these methods require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Attempts to breach these code protection features, most likely, cannot be accomplished without violating Microchip's intellectual property rights.
- Microchip is willing to work with any customer who is concerned about the integrity of its code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not mean that we are guaranteeing the product is "unbreakable." Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication is provided for the sole purpose of designing with and using Microchip products. Information regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WAR-RANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDI-RECT, SPECIAL, PUNITIVE, INCIDENTAL OR CONSEQUEN-TIAL LOSS, DAMAGE, COST OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PackeTime, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, FlashTec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, Augmented Switching, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, IdealBridge, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, Inter-Chip Connectivity, JitterBlocker, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, simpleMAP, SimpliPHY, SmartBuffer, SMART-I.S., storClad, SQI, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, TSHARC, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries

All other trademarks mentioned herein are property of their respective companies

© 2021, Microchip Technology Incorporated, All Rights Reserved.

ISBN: 978-1-5224-7737-2

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200

Fax: 480-792-7200 Fax: 480-792-7277 Technical Support:

http://www.microchip.com/ support

support Web Address:

www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614

Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Dallas Addison, TX Tel: 972-818-7423

Fax: 972-818-2924 **Detroit** Novi, MI

Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Fax: 317-773-5453 Tel: 317-536-2380 Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270 Canada - Toronto

Tel: 905-695-1980 Fax: 905-695-2078

ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

China - Beijing Tel: 86-10-8569-7000

China - Chengdu Tel: 86-28-8665-5511

China - Chongqing Tel: 86-23-8980-9588

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

China - Shanghai Tel: 86-21-3326-8000

China - Shenyang Tel: 86-24-2334-2829

China - Shenzhen Tel: 86-755-8864-2200

China - Suzhou Tel: 86-186-6233-1526

China - Wuhan Tel: 86-27-5980-5300

China - Xian Tel: 86-29-8833-7252

China - Xiamen
Tel: 86-592-2388138

China - Zhuhai Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

India - New Delhi Tel: 91-11-4160-8631

India - Pune Tel: 91-20-4121-0141

Japan - Osaka Tel: 81-6-6152-7160

Japan - Tokyo Tel: 81-3-6880- 3770

Korea - Daegu Tel: 82-53-744-4301

Korea - Seoul Tel: 82-2-554-7200

Malaysia - Kuala Lumpur Tel: 60-3-7651-7906

Malaysia - Penang Tel: 60-4-227-8870

Philippines - Manila Tel: 63-2-634-9065

Singapore Tel: 65-6334-8870

Taiwan - Hsin Chu Tel: 886-3-577-8366

Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600

Thailand - Bangkok Tel: 66-2-694-1351

Vietnam - Ho Chi Minh Tel: 84-28-5448-2100

EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen Tel: 45-4485-5910 Fax: 45-4485-2829

Finland - Espoo Tel: 358-9-4520-820

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Garching Tel: 49-8931-9700

Germany - Haan Tel: 49-2129-3766400

Germany - Heilbronn Tel: 49-7131-72400

Germany - Karlsruhe Tel: 49-721-625370

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Rosenheim Tel: 49-8031-354-560

Israel - Ra'anana Tel: 972-9-744-7705

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Padova Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7288-4388

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820